media detection Typical Specifications

One-way operation detector switch ideal for



Ite	ms	Specifications	
Rating (max.)/(m (Resistive load)	n.)	0.1A 30V DC / 100µA 3V DC	
Contact resistance (Initial / After ope	-	1 Ω max. / 2Ω max.	
Operating force		0.3N max.	
Operating life	Without load	100,000cycles	
Operating life	With load	100,000cycles (0.1A 30V DC)	

Product Line

Poles	Positions	Terminal type	Slider height (mm)	ON start position (mm)	Total travel position (mm)	Minimumord Japan	er unit (pcs) Export	Product No.	Drawing No.
		For PC board (Reflow)	h=6.1	h ₁ =5.6	h₂=4.45	1,000	4,000	SPPW812302	1
		For PC board (Dip)	11-0.1			100	20,000	SPPW812300	2
		For PC board (Reflow)	h=6.55	h ₁ =6.05	h ₂ =4.85	1,000	4,000	SPPW810201	1
1	1	For PC board (Dip)				100	20,000	SPPW810203	2
ı	'	For PC board (Reflow)	h=7.6		=7.1 h ₂ =5.9	850	3,400	SPPW811203	1
		For PC board (Dip)	11—7.0					SPPW811200	2
		For PC board (Reflow)	10.3	0.0	8.6	100	20,000	SPPW810401	3
		For PC board (Dip)	10.3	9.8				SPPW810400	4

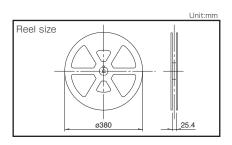
Note

Contact us for other slider height variations.

Packing Specifications

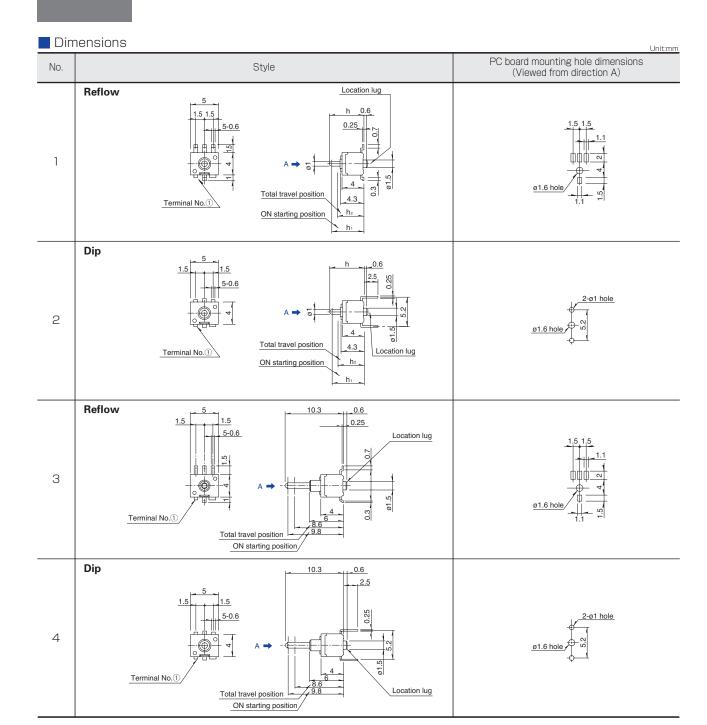
Taping

Product No.	Numbe	er of packages	Tape width	Export package measurements (mm)	
Floduct No.	1 reel	1 reel 1 case /Japan 1 case /export packing			
SPPW812302 SPPW810201	1,000	2,000	4,000	24	406×406×160
SPPW811203	850	1,700	3,400		



Bulk

Product No.	Number of pa	ckages (pcs.)	Export package measurements	
1 case /Japan 1 case /export p		1 case /export packing	(mm)	
SPPW812300 SPPW810203 SPPW811200 SPPW810401 SPPW810400	4,000	20,000	400×270×290	



- Notes 1. Dimensions drawing is for type with location lugs.
 - 2. Products without location lug are also available.

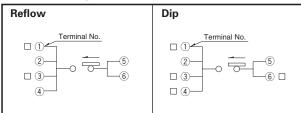
Terminal Layout (Viewed from Direction A)

Reflow	Dip
© \$ 4	(5) 4
O	(5) 4
1 2 3	(1) 2) 3

Notes 1. \square Mark shows a cutting terminal.

2. Contact us for other terminal types.

Circuit Diagram





		General-purpose Type							
5	Series	SPPW8	SSCQ	SSCM	SPVL	SPPB			
Photo				- See					
Oper	ation type	One-way	Two-way Two-direction type	Two-way	Three-way	One-way Two-way			
	W	5	3.8	5	5.55	6.3			
Dimensio (mm)	ns D	4	3.6	4	6.6	3			
()	Н	4	0.9	1.5	1	4.9			
Operating to	emperature range		-10℃ to +60℃		-40°C t	to +85℃			
Autor	notive use	_	_	_	•	•			
Life cycl	e (availability)	*3	*3	*3	*3	* 3			
Poles / Positions		1/1	1 / Two-direction type: 2-position each side	1/2	1	/1			
Rating (max.) (Resistive load)		0.1A 30V DC	1mA 5V DC 0.1A 30V D						
Rating (min.) (Resistive load)		100μA 3V DC	50µA 3V DC						
	Operating life without load	100,000cycles 2Ω max.	50,000cycles 5Ω max.			50,000cycles 2Ω max.			
Durability	Operating life with load Rating (max.) (Resistive load)	100,000cycles 2Ω max.		50,000cycles 5Ω max.		50,000cycles 2Ω max.			
	Initial contact resistance	1Ω max.		2Ω max.		1Ω max.			
Electrical performance	Insulation resistance			100MΩ min. 100V DC					
	Voltage proof			100V AC for 1 minute					
Mechanical	Terminal strength	3N for 1minute	0.5N for	Iminute	1N for 1minute	3N for 1minute			
performance	Actuator strength	10N	1N	2N	5N	10N			
Cold			-20°C 96h	-40°C 500h					
Environmental performance	Dry heat		85℃ 96h		85°C 500h				
	Damp heat		40°C, 90 to 95%RH 96h			95%RH 500h			
Opera	ation force	0.3N max.		0.35N	N max.				
	Page	29	31	32	33	34			

Note

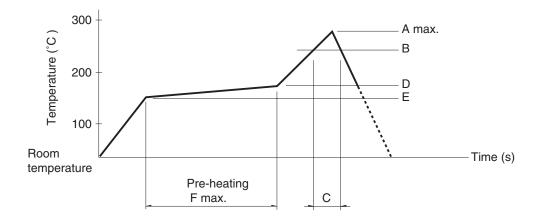
• Indicates applicability to all products in the series.

Example of Reflow Soldering Condition

- 1. Heating method: Double heating method with infrared heater.
 2. Temperature measurement: Thermocouple \$\phi 0.1\$ to 0.2 CA (K) or CC (T) at soldering portion (copper foil surface).
 A heat resisting tape should be used for fixed measurement.

Detector Switches Soldering Conditions

3. Temperature profile



Series (Reflow type)	A (℃) 3s max.	В (℃)	C (s)	D (°C)	E (℃)	F(s)
SPPB	250		40	180	150	120
SPPW8	250		35			
SPVE						
SPVL						
SPVM			40			
SPVN	260	230				
SPVR						
SPVS						
SPVT						
SSCM						
SSCQ						
SPVQC	250					

- 1. The condition mentioned above is the temperature on the mounting surface of a PC board. There are cases where the PC board's temperature greatly differs from that of the switch, surface depending on the PC board's material, size, thickness, etc. The above-stated conditions shall also apply to switch surface temperatures.
- 2. Soldering conditions differ depending on reflow soldering machines. Prior verification of soldering condition is highly recommended.

■ Reference for Hand Soldering

Series	Soldering temperature	Soldering time	
SPVS, SPVN, SPVT, SPVM, SPVR, SPVE, SPPW8,SSCQ, SSCM, SPVL, SSCT, SPVQC	350±5℃	3s max.	
SPVQ1, SPVQ3, SPVQ6, SPVQ7, SPVQ8, SPVQ9, SSCN, SPVQA	300±10℃	3+1/0s	
SPPB (Reflow)	300±5℃	5s max.	
SSCF, SPPB (For Lead, Dip)	350±10℃	3+1/0s	

■ Reference for Dip Soldering (For PC board terminal types)

	Ite	ms	Dip soldering	
Series	Preheating temperature	Preheating time	Soldering temperature	Duration of immersion
SSCT, SPVQ1, SPVQ3, SPVQ6, SPVQ7, SPVQ8, SPVQ9, SPVQA	100±10℃	60s max.	260±5℃	5±1s
SPPW8, SPPB	100 ℃ max.	60s max.	255±5℃	5±1s
SSCF	_		260±5℃	5±1s

